



RECOMMENDED PCB LAYOUT (THK: 1.0MM)

Material
 Housing Material: Thermoplastic PA9T, UL94V-0, green
 Contact Terminal: Brass
 Metallic Shell: Brass
 Plating
 Underplating: Nickel all over
 Contact Plating: 1µ" Gold
 Solder Tail: Tin
 Metallic Shell: Nickel
 Electrical
 Voltage Rating: 30 V AC
 Current Rating: 4A
 Contact Resistance: 30mΩ Max.
 Insulation resistance: 1000MΩ Min.
 Dielectric withstanding voltage: 500V AC/Minute
 Mechanical
 Durability: 5000 cycles
 Mating Force: 35N (3.57Kgf) Max
 Unmating Force: 10N (1.02Kgf)
 Environmental and Processing
 Operating Temperature: -40°C to +85°C

U234-05XN-3GRA035-5

- 1: Au 1U"
- 5: Au 15U"
- 6: Au 30U"
- G: GREEN
- B: BLACK
- BL: BLUE
- 1: PBT
- 2: PA6T
- 3: PA9T
- 4: LCP
- 5: BRASS

					ANGLAR	±5°	DSND		DATE	SCALE: N/A	MODEL TYPE: USB 3.0		
					L ≤ 4	±0.2	DWN		DATE	VIEW:	PART NO.:		
					4 < L ≤ 16	±0.3	CHKD		DATE	UNIT: mm/in	DWG NO.:		
					16 < L ≤ 63	±0.4	APPD		DATE	SIZE: A4	U234-05XN-3GRA035-5		
					L > 63	±0.5					WEIGHT	SHEET	REVISION
					UNSPECIFIED TOLERANCES		XKB INDUSTRIAL PRECISION CO., LIMITED				1.0g	1/1	A0
MARK	DESCRIPTION	DATE	REVISED	APPROVED									
REVISIONS													
www.xk-dg.cn www.helloxkb.com www.helloxkb.cn													

单击下面可查看定价，库存，交付和生命周期等信息

[>>XKB Connectivity\(中国星坤\)](#)